505269892 01/09/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
YUSHENG LIN	01/09/2019
JEROME TEYSSEYRE	01/08/2019

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
Street Address:	5005 E. MCDOWELL ROAD
Internal Address:	MAILDROP A700
City:	PHOENIX
State/Country:	ARIZONA
Postal Code:	85008

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16243505

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ATTORNEY DOCKET NUMBER:	ONS03029P01US	
NAME OF SUBMITTER:	SHARRON CASTILLO	
SIGNATURE:	/Sharron Castillo/	
DATE SIGNED:	01/09/2019	

Total Attachments: 3

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PATENT REEL: 047942 FRAME: 0453 505269892

ASSIGNMENT & AGREEMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby asknowledged, we,

Name of (City and State OR Country)

YUSHENG LIN
JEROME TEYSSEYRE

PHOENIX, ARIZONA US SCOTTSDALE, ARIZONA US

agree to sell, assign, and transfer, and do hereby sell, assign, and transfer to Semiconductor Components Industries, LLC, a limited liability company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives ("SCI"), the entire right, title, and interest in and to the inventions and discoveries as described, illustrated, and/or claimed in

Title: HIGH POWER MODULE PACKAGE STRUCTURES

Attorney Docket No.: ONS03029P01US

Serial No.: 16/243505

Filing Date: January 9, 2019

together with the entire right, title, and interest in and to the above listed application(s), and in and to any and all provisional, non-provisional, divisional, continuation, continuation-in-part, international, foreign, and any and all other applications related thereto, and also including any and all grants, issuances, letters patent, reissues, reexaminations, renewals, priority rights, and priority claims related to any of the foregoing, and any and all rights to collect past damages for infringement of any of the foregoing (the "Patent Rights").

We further authorize SCI to apply for and hold and maintain the Patent Rights throughout the world directly in its own name or any other name which SCI deems appropriate in its sole discretion, and to claim the priority of the filing date of the above listed application(s).

We agree that, when requested, we will, without charge to SCI, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing, maintaining, and enforcing the Patent Rights in any and all countries and for vesting title thereto in SCI or its nominees.

We represent and warrant that we have full right to convey the entire right, title and interest herein sold, assigned, and transferred, and that the Patent Rights hereby conveyed are free from all prior assignment, grant, mortgage, license, or other encumbrance to anyone other than SCI. We covenant and further warrant that we will not convey hereafter any part of the Patent Rights to anyone other than SCI or do any act whatsoever conflicting with this ASSIGNMENT & AGREEMENT.

We hereby authorize SCI or anyone it may properly designate to insert in this ASSIGNMENT & AGREEMENT the filing date and serial number of the above listed application(s) when ascertained. More than one counterpart of this ASSIGNMENT & AGREEMENT may be executed, each of which will be deemed an original.

PATENT REEL: 047942 FRAME: 0454 Yusheng Lin

ACKNOWLEDGMENT

State of Arizona

)

County of Maricopa

On this $\frac{2^{4/3}}{2^{4/3}}$ day of $\frac{2^{4/3}}{2^{4/3}}$, before me personally appeared, **Yusheng Lin**, whose identity was proven to me on the basis of satisfactory evidence to be the person who he/she claims to be, and acknowledged that he/she signed the above/attached document.

(seal)

SHARRON CASTILLO
Nitary Public - State of Africana
MARICOPA COUNTY
My Commission Expires
Merch 26, 2019

Notary Public

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Jerome Teysseyre		
ACKNOWLEDGMENT		
State of Arizona)	
County of Maricopa	ĵ	
identity was proven to		e me personally appeared, Jerome Teysseyre, whose ory evidence to be the person who he/she claims to ve/attached document.
(seal)	SHARRON CASTILLO Notary Public - State of Arizons MARICOPA COUNTY My Commission Expires March 26, 2019	Shum Custillo Notary Public

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RECORDED: 01/09/2019